ONSEMÍ,

MOSFET – N-Channel, POWERTRENCH[®]

40 V, 18 A, 26 m Ω

FDMC8015L

General Description

This N–Channel MOSFET is produced using **onsemi**'s advanced POWERTRENCH process that has been especially tailored to minimize the on–state resistance and yet maintain superior switching performance.

Features

- Max $R_{DS(on)} = 26 \text{ m}\Omega$ at $V_{GS} = 10 \text{ V}$, $I_D = 7 \text{ A}$
- Max $R_{DS(on)} = 36 \text{ m}\Omega$ at $V_{GS} = 4.5 \text{ V}$, $I_D = 6 \text{ A}$
- Low Profile 1 mm Max in Power 33
- 100% UIL Tested
- This Device is Pb-Free, Halide Free and is RoHS Compliant

Applications

- Load Switch
- Motor Bridge Switch

| WOSPET WAXIMUM RATINGS ($T_A = 25^{\circ}$ C, unless otherwise noted) | | | | | |
|---|---|---------------------|------|--|--|
| Symbol | Parameter | Ratings | Unit | | |
| V _{DS} | Drain to Source Voltage | 40 | V | | |
| V _{GS} | Gate to Source Voltage | ±20 | V | | |
| ID | Drain Current – Continuous (Package Limited) $T_C = 25^{\circ}C$ – Continuous (Silicon Limited) $T_C = 25^{\circ}C$ – Continuous $T_A = 25^{\circ}C$ (Note 1a) – Pulsed | 18 22 7 30 | A | | |
| E _{AS} | Single Pulse Avalanche Energy (Note 3) | 32 | mJ | | |
| PD | Power Dissipation $T_{C} = 25^{\circ}C$ $T_{A} = 25^{\circ}C$ (Note 1a) | 24 2.3 | W | | |
| T _J , T _{STG} | Operating and Storage Junction Temperature Range | –55 to +150 | °C | | |

MOSFET MAXIMUM RATINGS ($T_A = 25^{\circ}C$, unless otherwise noted)

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

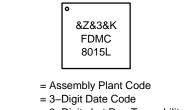
THERMAL CHARACTERISTICS ($T_A = 25^{\circ}C$, unless otherwise noted)

| Symbol | Parameter | Ratings | Unit |
|------------------|---|---------|------|
| R _{0JC} | Thermal Resistance, Junction to Case | 5.1 | °C/W |
| R _{θJA} | Thermal Resistance, Junction to Ambient (Note 1a) | 53 | |

| V _{DS} | R _{DS(on)} MAX | I _D MAX |
|-----------------|-------------------------|--------------------|
| 40 V | 26 mΩ @ 10 V | 18 A |
| | 36 mΩ @ 4.5 V | |



MARKING DIAGRAM

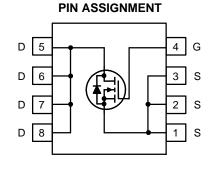


&K = 2-Digits Lot Run Traceability Code FDMC8015L = Device Code

JNC8015L = Device Coc

&Z

&3



ORDERING INFORMATION

See detailed ordering and shipping information on page 5 of this data sheet.

FLECTRICAL CHARACTERISTICS (T. - 25°C unless otherwise noted)

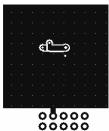
| Symbol | Parameter | Test Condition | Min | Тур | Max | Unit |
|--|---|---|-----|------|------|-------|
| OFF CHAR | ACTERISTICS | - - | | | | |
| BV DSS | Drain to Source Breakdown Voltage | $I_D = 250 \ \mu A, \ V_{GS} = 0 \ V$ | 40 | - | - | V |
| $\frac{\Delta BV_{DSS}}{\Delta T_{J}}$ | Breakdown Voltage Temperature Coefficient | $I_D = 250 \ \mu\text{A}$, referenced to 25°C | - | 36 | - | mV/°C |
| IDSS | Zero Gate Voltage Drain Current | $V_{DS} = 32 \text{ V}, V_{GS} = 0 \text{ V}$ | - | - | 1 | μA |
| I _{GSS} | Gate to Source Leakage Current | $V_{GS} = \pm 20 \text{ V}, V_{DS} = 0 \text{ V}$ | - | - | ±100 | nA |
| ON CHARA | CTERISTICS | | | - | - | |
| V _{GS(th)} | Gate to Source Threshold Voltage | $V_{GS} = V_{DS}, I_{D} = 250 \ \mu A$ | 1 | 1.8 | 3 | V |
| $\frac{\Delta V_{GS(th)}}{\Delta T_J}$ | Gate to Source Threshold Voltage Temperature Coefficient | $I_D = 250 \ \mu\text{A}$, referenced to 25°C | - | -6 | - | mV/°C |
| R _{DS(on)} | Static Drain to Source On Resistance | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 7 \text{ A}$ | - | 19.7 | 26 | mΩ |
| | | $V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 6 \text{ A}$ | - | 24 | 36 | mΩ |
| | | $V_{GS} = 10 \text{ V}, \text{ I}_{D} = 7 \text{ A}, \text{ T}_{J} = 125^{\circ}\text{C}$ | - | 29 | 39 | mΩ |
| 9fs | Forward Transconductance | $V_{DD} = 5 V, I_D = 7 A$ | - | 30 | - | S |
| DYNAMIC (| CHARACTERISTICS | | | | | |
| C _{iss} | Input Capacitance | $V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$ | - | 710 | 945 | pF |
| C _{oss} | Output Capacitance | | - | 94 | 125 | pF |
| C _{rss} | Reverse Transfer Capacitance | | - | 58 | 90 | pF |
| Rg | Gate Resistance | | - | 1.2 | - | Ω |
| SWITCHING | G CHARACTERISTICS | | | | | |
| t _{d(on)} | Turn–On Delay Time | $V_{DD} = 20 \text{ V}, \text{ I}_{D} = 7 \text{ A}, \text{ V}_{GS} = 10 \text{ V},$ | - | 6.3 | 13 | ns |
| t _r | Rise Time | $R_{GEN} = 6 \Omega$ | - | 1.9 | 10 | ns |
| t _{d(off)} | Turn–Off Delay Time | | - | 18 | 33 | ns |
| t _f | Fall Time | | - | 1.7 | 10 | ns |
| Q _{g(TOT)} | Total Gate Charge | $V_{GS} = 0 V$ to 10 V, $V_{DD} = 20 V$, $I_D = 7 A$ | - | 13.6 | 19 | nC |
| Q _{g(TOT)} | Total Gate Charge | $V_{GS} = 0 V$ to 4.5 V, $V_{DD} = 20 V$, $I_D = 7 A$ | - | 6.6 | 10 | nC |
| Q _{gs} | Gate to Source Charge | V _{DD} = 20 V, I _D = 7 A | - | 1.9 | - | nC |
| Q _{gd} | Gate to Drain "Miller" Charge | V _{DD} = 20 V, I _D = 7 A | - | 2.5 | - | nC |

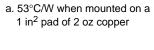
DRAIN-SOURCE CHARACTERISTICS

| V _{SD} | Source to Drain Diode Forward Voltage | $V_{GS} = 0 V, I_{S} = 7 A (Note 2)$ | - | 0.84 | 1.2 | V |
|-----------------|---------------------------------------|--|---|------|-----|----|
| | | $V_{GS} = 0 V, I_{S} = 2 A (Note 2)$ | - | 0.76 | 1.1 | V |
| t _{rr} | Reverse Recovery Time | I _F = 7 A, di/dt = 100 A/μs | - | 18 | 33 | ns |
| Q _{rr} | Reverse Recovery Charge | | - | 8.6 | 18 | nC |

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 1. $R_{\theta JA}$ is determined with the device mounted on a 1 in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta JC}$ is guaranteed

by design while $R_{\theta CA}$ is determined by the user's board design.





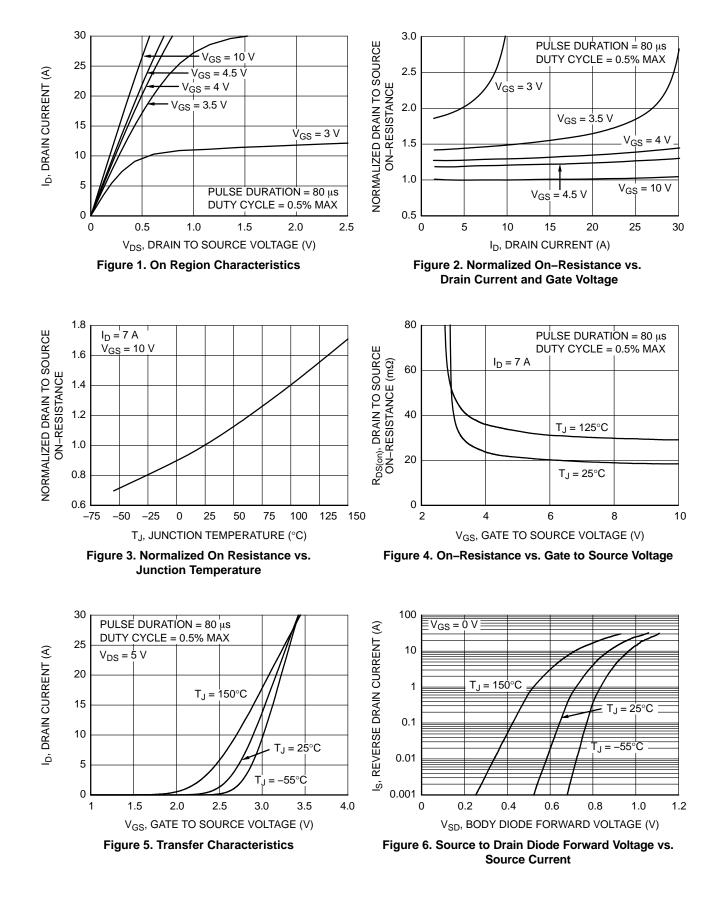


b. 125°C/W when mounted on a minimum pad of 2 oz copper

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2. Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%. 3. Starting T_J = 25°C; N-ch: L = 1 mH, I_{AS} = 8 A, V_{DD} = 36 V, V_{GS} = 10 V.

TYPICAL CHARACTERISTICS ($T_J = 25^{\circ}C$, unless otherwise noted)



TYPICAL CHARACTERISTICS (T_J = 25°C, unless otherwise noted) (continued)

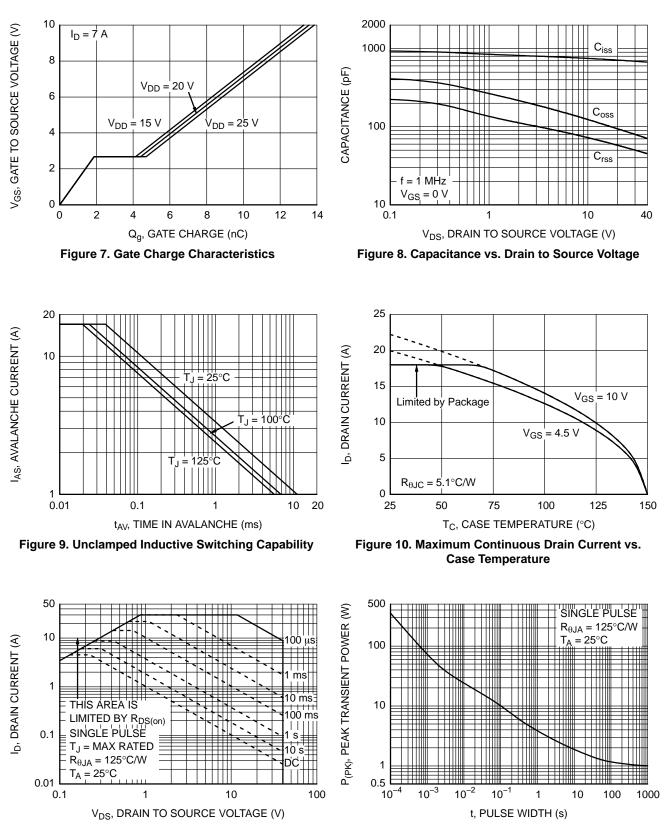


Figure 11. Forward Bias Safe Operating Area



TYPICAL CHARACTERISTICS (T_J = 25°C, unless otherwise noted) (continued)

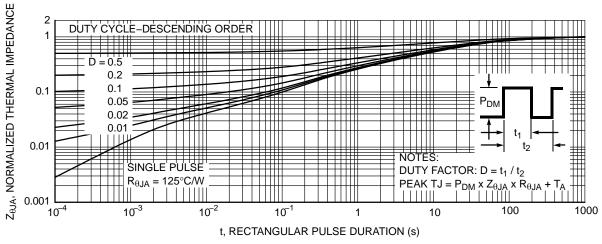


Figure 13. Junction-to-Ambient Transient Thermal Response Curve

PACKAGE MARKING AND ORDERING INFORMATION

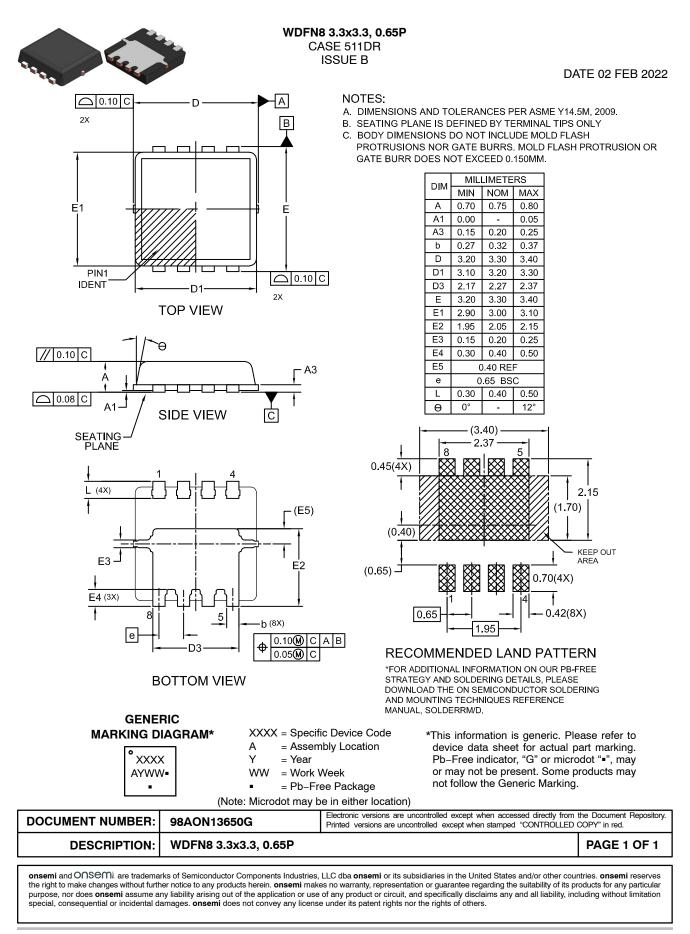
| Device | Device Marking | Package | Reel Size | Tape Width | Shipping [†] |
|-----------|----------------|--|-----------|------------|-----------------------|
| FDMC8015L | FDMC8015L | WDFN8 3.3x3.3, 0.65P (Pb–Free, Halide Free) | 13" | 12 mm | 3000 / Tape & Reel |

+For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

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MECHANICAL CASE OUTLINE

PACKAGE DIMENSIONS



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